b2	1,14	1,78	.045	.070	
b3	1,14	1.73	.045	.068	5
С	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	5
c2	1,14	1.65	.045	.065	
D	8,38	9,65	.330	.380	3
D1	6.86	-	.270	-	4
E	9.65	10.67	.380	.420	3,4
E1	6.22	-	.245	-	4
e	2.54 BSC		,100 BSC		
Н	14.61	15.88	.575	.625	
L	1.78	2.79	,070	,110	
L1	-	1.68	-	,066	4
L2	-	1,78	-	.070	
L3	0.25 BSC		.010 BSC		1

- 6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 7. CONTROLLING DIMENSION: INCH.
- 8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263AB.

LEAD ASSIGNMENTS

DIODES

1.- ANODE (TWO DIE) / OPEN (ONE DIE)
2. 4.- CATHODE
3.- ANODE

HEXFET

1,- GATE 2, 4,- DRAIN 3.- SOURCE

IGBTs, CoPACK 1,- GATE 2, 4.- COLLECTOR 3,- EMITTER

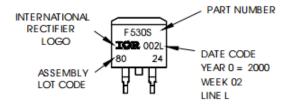
D²Pak (TO-263AB) Part Marking Information

EXAMPLE: THIS IS AN IRF530S WITH

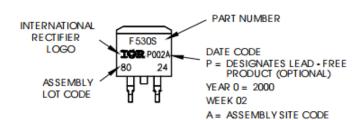
LOT CODE 8024 ASSEMBLED ON WW 02, 2000

IN THE ASSEMBLY LINE "L"

Note: "P" in assembly line position indicates "Lead - Free"



OR



Note: For the most current drawing please refer to IR website at http://www.irf.com/package/